

PolarHT[™] Power MOSFET

IXTQ 140N10P IXTT 140N10P

 $V_{DSS} = 100 V \ I_{D25} = 140 A \ R_{DS(on)} \le 11 m\Omega$

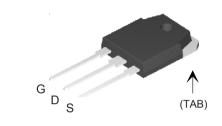
N-Channel Enhancement Mode Avalanche Rated



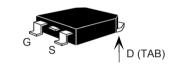
Symbol	Test Conditions	Maximum	Maximum Ratings		
V _{DSS} V _{DGR}	$T_J = 25^{\circ} C \text{ to } 175^{\circ} C$ $T_J = 25^{\circ} C \text{ to } 175^{\circ} C; R_{GS} = 1 \text{ M}Ω$	100 100	V		
V _{GS}	Continuous Transient	±20 ±30	V V		
I _{D25}	T _C =25°C	140	А		
D(RMS)	External lead current limit	75	Α		
I _{DM}	$T_{\rm C}$ = 25° C, pulse width limited by $T_{\rm JM}$	300	Α		
I _{AR}	T _C = 25° C	60	Α		
E _{AR}	T _C = 25° C	80	mJ		
E _{AS}	T _C = 25° C	2.5	J		
dv/dt	$I_{S} \leq I_{DM}$, di/dt ≤ 100 A/ μ s, $V_{DD} \leq V_{DSS}$, $T_{J} \leq 150$ °C, $R_{G} = 4$ Ω	10	V/ns		
P _D	T _C =25°C	600	W		
 T _J		-55 +175 175	°C		
T _{JM} T _{stg}		-55 +150	°C		
T _L T _{SOLD}	1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 s	300 260	°C		
M _d	Mounting torque (TO-3P)	1.13/10	Nm/lb.in.		
Weight	TO-3P TO-268	5.5 5.0	g g		

Symbol (T _J = 25° C, t	Test Conditions unless otherwise specified)		Ch Min.	aracteri Typ.	stic Va Max	
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		100			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		3.0		5.0	V
GSS	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$				±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T _J = 175° C			25 500	μA μA
R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}$ $V_{GS} = 15 \text{ V}, I_{D} = 300 \text{ A}$ Pulse test, t \(\le 300 \mu \text{s}, \text{ duty} \)	cycle d ≤ 2 %		9	11	mΩ mΩ

TO-3P (IXTQ)



TO-268 (IXTT)



G = Gate D = Drain S = Source TAB = Drain

Features

- ¹ International standard packages
- Unclamped Inductive Switching (UIS) rated
- ¹ Low package inductance
 - easy to drive and to protect

Advantages

- ^I Easy to mount
- Space savings
- High power density

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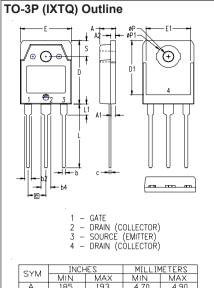


Symbo	ol	Test Conditions	Characteristic Values 25° C, unless otherwise specified)		
			Min.	Typ.	Max.
g_{fs}		V_{DS} = 10 V; I_{D} = 0.5 I_{D25} , pulse test	45	65	S
C _{iss})			4700	pF
C _{oss}	}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1850	pF
\mathbf{C}_{rss}	J			600	pF
t _{d(on)})			35	ns
t _r		$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 60 \text{ A}$		50	ns
$\mathbf{t}_{d(off)}$		$R_{_{G}} = 4 \Omega $ (External)		85	ns
t _f)			26	ns
$\mathbf{Q}_{g(on)}$)			155	nC
\mathbf{Q}_{gs}	}	V_{GS} = 10 V, V_{DS} = 0.5 V_{DSS} , I_{D} = 0.5 I_{D25}		33	nC
\mathbf{Q}_{gd}	J			85	nC
R _{thJC}					0.25°C/W
$\mathbf{R}_{ ext{thCS}}$		(TO-3P)		0.21	°C/W

Source-Drain Diode

Characteristic Values (T, = 25°C, unless otherwise specified)

Symbol	Test Conditions	Min.	Тур.	Max.	
I _s	$V_{GS} = 0 V$			140	Α
I _{sm}	Repetitive			300	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0 \text{ V}$, Pulse test, t ≤300 µs, duty cycle d≤ 2 %			1.5	V
$\begin{bmatrix} \mathbf{t}_{rr} & \\ \mathbf{Q}_{RM} \end{bmatrix}$	$I_F = 25 \text{ A}, -\text{di/dt} = 100 \text{ A/}\mu\text{s}$ $V_R = 50 \text{ V}, V_{GS} = 0 \text{ V}$		120 2.0		ns μC



SYM	INCH	1ES	MILLIMETER:	
STIM	MIN	MAX	MIN	MAX
Α	.185	.193	4.70	4.90
A1	.051	.059	1.30	1.50
A2	.057	.065	1.45	1.65
Ь	.035	.045	0.90	1.15
b2	.075	.087	1.90	2.20
b4	.114	.126	2.90	3.20
С	.022	.031	0.55	0.80
D	.780	.799	19.80	20.30
D1	.665	.677	16.90	17.20
E	.610	.622	15.50	15.80
E1	.531	.539	13.50	13.70
е	.215 BSC		5.45	BSC
L	.779	.795	19.80	20.20
L1	.134	.142	3.40	3.60
ØΡ	.126	.134	3.20	3.40
ØP1	.272	.280	6.90	7.10
S	.193	.201	4.90	5.10
	.170		1130	0.10

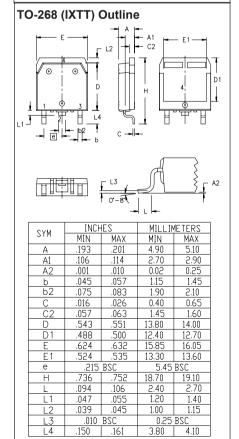
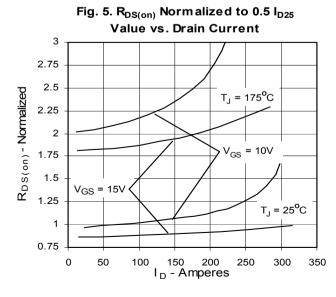
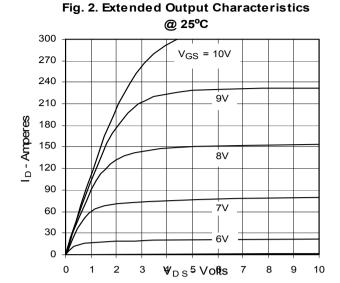


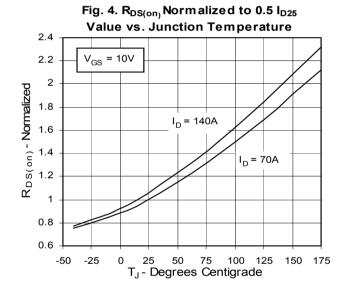
Fig. 1. Output Characteristics @ 25°C 140 $V_{GS} = 10V$ 120 100 I_D - Amperes 80 8V 60 7V 40 20 6V 0 0.2 0.4 0.6 0.8 1.2 0 1.4 1.6 V_{DS} - Volts

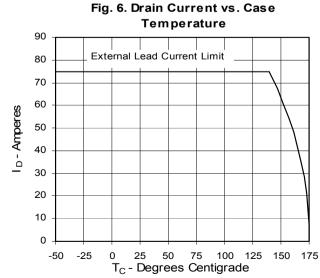
Fig. 3. Output Characteristics @ 150°C 140 $V_{GS} = 10V$ 120 100 I D - Amperes 8V 80 60 6V 40 20 5V 0 1.6 0.4 0.8 2 2.4 2.8 3.2

V_{DS} - Volts

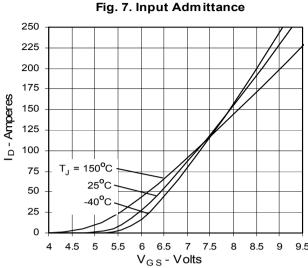


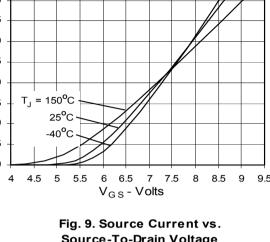


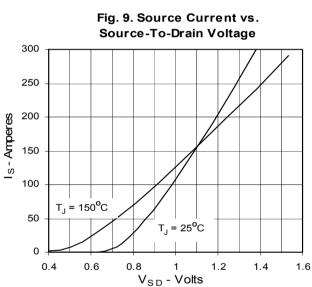


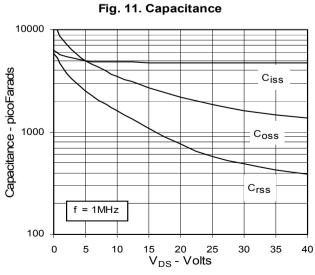


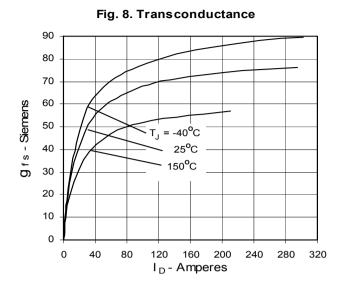


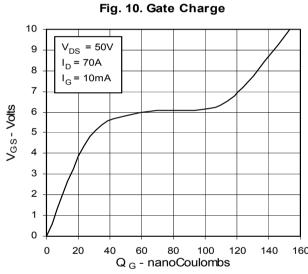


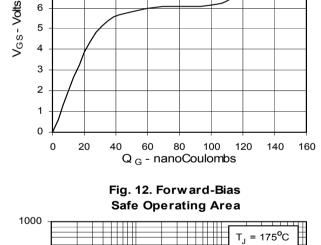


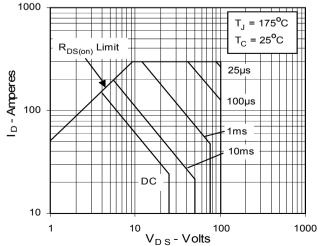












IXYS reserves the right to change limits, test conditions, and dimensions.



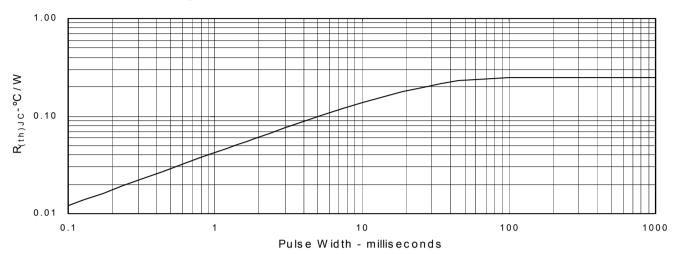


Fig. 13. Maximum Transient Thermal Resistance

